

Products pecification

1. Scope

This specification applies to the 1.0mm pitch FPC/FFC series connectors,specifying the product's performance indicators,test methods and testrequirements. (Applicable Product Model:FFC10065 series)

2. Connector Dimensions

Refer to the drawing.

3. Materials and Plating

- A. Housing : Thermoplastic Without Halogen, UL94V-0,Color: Nature;
- B. Cover : Thermoplastic Without Halogen, UL94V-0,Color: Black;
- C. Contact : Copper Alloy, Gold or Tin plating over Nickel under plating Overall.
- D. Peg : Copper Alloy, Tin Plating over Nickel under plating overall.

4. Applicable P.C.B. Layout

Refer to the drawing

5. Rating

Operating Voltage: 50V AC

Current Rating: 0.5ADC

Operating Temperature: -40℃~+105℃ (Including Terminal Temperature Rise)

6 TEST CONDITION

The test and measurement, unless otherwise specified, shall be carryout at a temperature of 15 to 35℃, Relative humidity of 25 to 85%,and atmospheric pressure of 86 to 106KPa. However, when any doubt arises on the judgment value under it, the test and measurement shall be carry out at a temperature of 20±2℃, relative humidity of 60 to 70%, and atmospheric pressure of 86 to 106KPa.

7. Performance

Test Item	Requirement	Test Condition
Examination of Product	Meets requirements of Product drawing, NO Breakdown	Visual inspection.

Electrical Performance

Contact resistance	30mΩ Max.	Mate applicable FPC and measure by dry circuit 20mV Max,10mA
Insulation resistance	500mΩ Min.	[500]VAC for 1 minute Test between adjacent circuits of unmated connector.
Withstanding Voltage	No breakdown, flashover, or arcing	[250]VAC for 1 minute Test between adjacent circuits of unmated connector.

Mechanical Performance

Contact Retention Force	0.250kgf Min.		Apply axial pull out force at the rate of [25.4±3]mm/min on the terminal assembled in the housing.
FPC/FFC Retention Force	Operation Speed:[25.4±3]mm/min Measure the force required to unmated connector.		0.030kgf/Pin Min.(PIN>= 17) 0.050kgf/ Min.(PIN<17)
Durability	Appearance	No damage	Operation Speed: (10) cycle-max./min Durability Cycles: 20 Cycles
	Contact resistance	60mΩ Max.	
Vibration	Appearance	No damage	Amplitude: 1.52mm Frequency: 10~55~10HZ 2 hours in X,Y,Z directions, total 6 cycles
	Contact resistance	60mΩ Max.	
	Discontinuity	1μs Max	
Mechanical Shock	Appearance	No damage	The connectors shall be soldered on the P.C. board. /Acceleration: 50G. Time: 11ms.(half sine wave). Cycle: 3 cycle for 3 axis total 9 cycle.
	Contact resistance	60mΩ Max.	
	Discontinuity	1μs Max	
Temperature Rising	Temperaturerise	30°C max	Mate applicable FPC and measure the temperature rise of contact when the maximum AC mated current is.
Solder ability	≥95% solder coverage, no voids, cold joints, etc.		Dwell time: 3±0.5 seconds Solder temperature: 245±5 °C

Environmental & Other Performance

Resistance to Reflow Soldering Heat	Appearance	No damage	Pre Heat:150~180℃,90±30sec. Heat: 230℃ Min.,30±10sec Peak Temp.:260+0/-5℃, 10sec. Or less Duration: 3 cycles Refer to Fig.2
Thermal shock	Contact Resistance	60mΩ Max.	Mated connectors, 5 cycles: -55℃ for 30 min → +85℃ for 30 min
Humidity-Temp erature Cycle	Appearance	No damage	40 ± 2 °C in temperature and 90~95%RH for 96 hours.After testing connector shall be left alone for 1 to 2 hours in a room ambient.
Temperature life	Contact Resistance	60mΩ Max.	Mated connectors, 85℃ for 250 hours
Salt Spray	Appearance	No damage	Mated connectors, 35±2℃, 5±1% NaCl, 24 hours (or as customer required)
	Contact Resistance	60mΩ Max.	

8. Test Sequence

Test Item	Test Group									
	1	2	3	4	5	6	7	8	9	10
	Test Sequence									
Examination of Product	1, 7	1, 9	1, 6	1, 5	1, 5	1, 5	1, 5	1, 3	1, 3	1, 3
Contact resistance		2, 8	2, 5	2, 4	2, 4	2, 4	2, 4			
Withstanding Voltage	3, 6									
Insulation resistance	2, 5									
Contact/ Peg Retention Force		3, 7								
FPC/FFC Retention Force		4, 6								
Durability		5								
Vibration			3							
Mechanical Shock			4							
Temperature Rising							2			
Solder ability									2	
Resistance to Soldering Heat								2		
Thermal Shock				3						
Humidity Temperature Cycling	4				3					
Temperature Life						3				
Salt Spray Cycling							3			

Note: Numbers indicate test sequence.

Refer to Fig.2: Resistance to Reflow Soldering Heat

